



GE Energy

## Functional Testing Specification

Inspection & Repair Services  
Louisville, KY

LOU-GEF-JLRI1

### Test Procedure for JLRI1 Printed Circuit Board

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<p><b>LOU-GEF-JLRI REV. A</b></p>	<p><b>g</b></p> <p><b>GE Energy</b> <i>Inspection &amp; Repair Services</i> <i>Louisville, KY</i></p>	<p><b>Page 2 of 3</b></p>
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## Functional test procedure for JLRI Printed Circuit Board

### 1. SCOPE

- 1.1 This specification provides the Engineering Requirements for testing the JLRI1 and JLRI1A printed circuit board 44A294543-G01

### 2. STANDARDS OF QUALITY

- 2.1 Refer to the current revision of the IPC-A-610 standard for workmanship standards.

### 3. APPLICABLE DOCUMENTS

- 3.1 The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
- 3.1.1 **44C286271** Schematics

### 4. ENGINEERING REQUIREMENTS

- 4.1 Description
- 4.1.1 Custom Relay Interface board for 1050H Control.
- 4.2 Equipment Cleaning
- 4.2.1 Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to the local documented procedures for cleaning guidelines.
- 4.3 Equipment Inspection
- 4.3.1 Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
- 4.3.1.1 Wires broken or cracked
- 4.3.1.2 Terminal strips / connectors broken or cracked
- 4.3.1.3 Loose wires
- 4.3.1.4 Components visually damaged
- 4.3.1.5 Capacitors leaking
- 4.3.1.6 Solder joints damaged or cold
- 4.3.1.7 Circuit board burned or de-laminated
- 4.3.1.8 Printed wire runs burned or damaged

## **EQUIPMENT REQUIRED**

- 4.4** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1	Fluke	Multimeter
1	DC Power Supply	+20VDC

## **5. TESTING PROCESS**

- 5.1.1** Bench Test
  - Test each Reed Relay
- 5.1.2** Set Power Supply to +20V (turn Off)
- 5.1.3** Connect P.S. lead to coil (K1 connect to D1, K2 connect to D2, etc.)
- 5.1.4** Connect Meter (set for Ohm reading) across relay contacts. Note: some relays have multiple contacts and poles.
- 5.1.5** Turn on power supply meter should read less then 1 Ohm.
  - 5.1.5.1** Repeat test for each relay.
- 5.1.6** \*\*\***TEST COMPLETE** \*\*\*

## **6. REFERENCES**

- 6.1** None at this time